

DECLARATION FOR PATENT APPLICATION

As a below named inventor, I declare:

that I verily believe myself to be the original, first and sole (if only one individual inventor is listed below) or an original, first and joint inventor (if more than one individual inventor is listed below) of the invention in

METHOD OF BONDING SUBSTRATES AND APPARATUS FOR BONDING SUBSTRATES

the specification of which is attached hereto unless the following box is checked.

- ☐ was filed on _____ as United States Application
or PCT International Application No. _____, and
was amended on _____ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information of which is material to patentability as defined in 37 CFR 1.56.

I hereby claim foreign priority benefits under 35 U.S.C. 119(a)-(d) or 365(b) of any foreign application(s) for patent or inventor's certificate, or 35 U.S.C. 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed:

Country	Category	Application Number	Filing Date	Priority Claim
Japan	Patent	2003-057295	March 4, 2003	Yes
Japan	Patent	2003-075785	March 19, 2003	Yes

I hereby appoint as my attorneys, with full power of substitution and revocation, to prosecute this application and transact all business in the Patent and Trademark Office connected therewith: the practitioners at:

Customer Number : 3624

of Volpe and Koenig, P.C.. Please address all correspondence and telephone communications to the address and telephone number for this Customer Number.

I declare further that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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(04S0157-1)

I declare further that my citizenship, residence and mailing address are as stated below next to my name:

Inventor:(signature)Date:Residence and mailing address

Shinichi Ogimoto
Shinichi Ogimoto

Date:Feb. 17, 2004Citizen of: Japan

c/o Shibaura Mechatronics Corporation,
Yokohama Operations, 5-1, Kasama
2-chome, Sakae-ku, Yokohama-shi,
Kanagawa-ken, Japan

Date:Citizen of:Date:Citizen of:Date:Citizen of:Date:Citizen of:Date:Citizen of:Date:Citizen of: